

Data Sheet July 2011

## 6A, 600V Hyperfast Diodes

The RHRD660S9A\_F085 is hyperfast diodes with soft recovery characteristics ( $t_{rr}$  < 30ns). It has half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as freewheeling/ clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Formerly developmental type TA49057.

## **Ordering Information**

PART NUMBER	PACKAGE	BRAND
RHRD660S9A_F085	TO-252	RHR660

### Features

•	Hyperfast with Soft Recovery<30ns
•	Operating Temperature
•	Reverse Voltage Up To

- · Avalanche Energy Rated
- Planar Construction

## **Applications**

- Switching Power Supplies
- · Power Switching Circuits
- · General Purpose

## **Packaging**

**JEDEC STYLE TO-252** 



# Symbol



## **Absolute Maximum Ratings** $T_C = 25^{\circ}C$ , Unless Otherwise Specified

	RHRD660S9A_F085	UNITS
Peak Repetitive Reverse Voltage	600	V
Working Peak Reverse Voltage	600	V
DC Blocking VoltageV <sub>R</sub>	600	V
Average Rectified Forward Current $I_{F(AV)}$ ( $T_C = 152^{\circ}C$ )	6	Α
Repetitive Peak Surge Current	12	Α
Nonrepetitive Peak Surge Current	60	Α
Maximum Power Dissipation	50	W
Avalanche Energy (See Figures 10 and 11)	10	mJ
Operating and Storage Temperature	-65 to 175	°C
Maximum Lead Temperature for Soldering		
(Leads at 0.063 in. (1.6mm) from case for 10s)	300	°C
Package Body for 10s, see Tech Brief 334T <sub>PKG</sub>	260	°C

### RHRD660S9A F085

**Electrical Specifications**  $T_C = 25^{\circ}C$ , Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V <sub>F</sub>	I <sub>F</sub> = 6A	-	-	2.1	V
	$I_F = 6A, T_C = 150^{\circ}C$	-	-	1.7	V
I <sub>R</sub>	V <sub>R</sub> = 600V	-	-	100	μΑ
	$V_R = 600V, T_C = 150^{\circ}C$	-	-	500	μΑ
t <sub>rr</sub>	$I_F = 1A$ , $dI_F/dt = 200A/\mu s$	-	-	30	ns
	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	-	35	ns
t <sub>a</sub>	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	16	-	ns
t <sub>b</sub>	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	8.5	-	ns
Q <sub>RR</sub>	$I_F = 6A$ , $dI_F/dt = 200A/\mu s$	-	45	-	nC
СЛ	V <sub>R</sub> = 10V, I <sub>F</sub> = 0A	-	20	-	pF
$R_{ heta JC}$		-	-	3	°C/W

### **DEFINITIONS**

 $V_F$  = Instantaneous forward voltage (pw = 300 $\mu$ s, D = 2%).

I<sub>R</sub> = Instantaneous reverse current.

 $t_{rr}$  = Reverse recovery time (See Figure 9), summation of  $t_a + t_b$ .

 $t_a$  = Time to reach peak reverse current (See Figure 9).

 $t_b$  = Time from peak  $I_{RM}$  to projected zero crossing of  $I_{RM}$  based on a straight line from peak  $I_{RM}$  through 25% of  $I_{RM}$  (See Figure 9).

Q<sub>RR</sub> = Reverse recovery charge.

 $C_J$  = Junction capacitance.

 $R_{\theta,JC}$  = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

# **Typical Performance Curves**

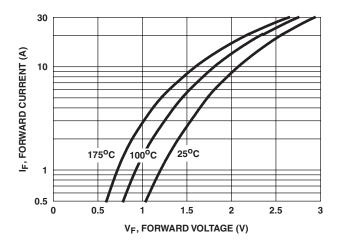


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

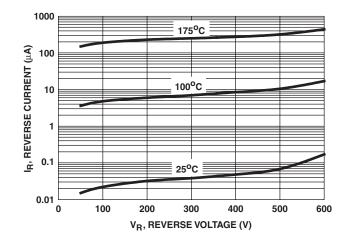


FIGURE 2. REVERSE CURRENT vs REVERSE

# Typical Performance Curves (Continued)

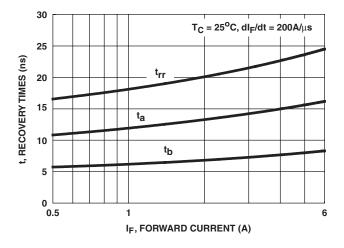


FIGURE 3.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

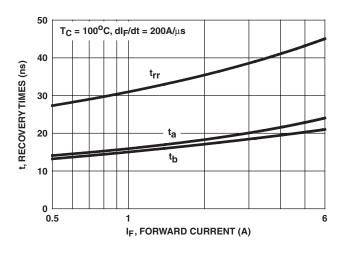


FIGURE 4. t<sub>rr</sub>, t<sub>a</sub> AND t<sub>b</sub> CURVES vs FORWARD CURRENT

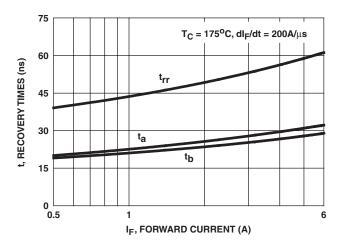


FIGURE 5.  $t_{rr}$ ,  $t_a$  AND  $t_b$  CURVES vs FORWARD CURRENT

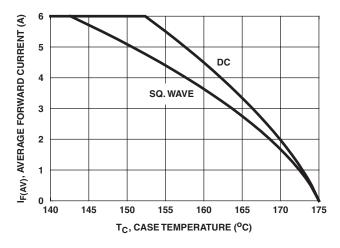


FIGURE 6. CURRENT DERATING CURVE

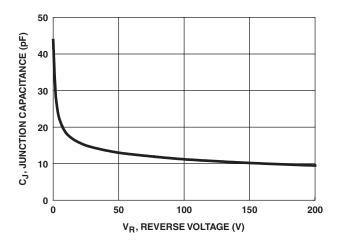


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

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### Test Circuits and Waveforms

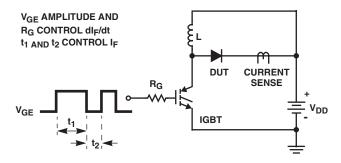


FIGURE 8. t<sub>rr</sub> TEST CIRCUIT

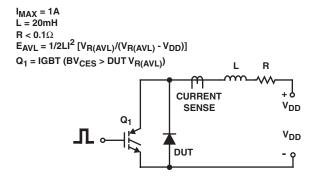


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

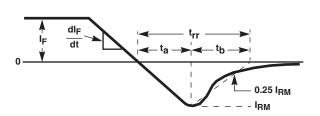


FIGURE 9. t<sub>rr</sub> WAVEFORMS AND DEFINITIONS

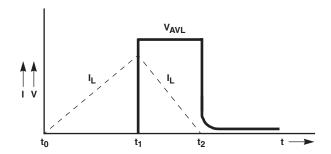


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS





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